



NPN SILICON RF POWER TRANSISTOR

DESCRIPTION:

The **ASI OSC-2.0SM** is Designed for

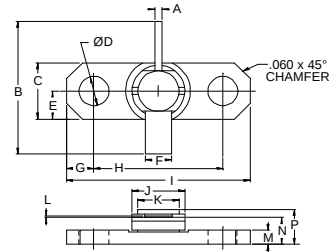
FEATURES:

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- **Omnigold™** Metalization System

MAXIMUM RATINGS

I_C	700 mA
V_{CC}	30 V
P_{DISS}	17.6 W @ $T_C \leq 50^\circ\text{C}$
T_J	-65°C to $+200^\circ\text{C}$
T_{STG}	-65°C to $+200^\circ\text{C}$
θ_{JC}	7.0 $^\circ\text{C/W}$

PACKAGE STYLE .250 2L FLG



DIM	MINIMUM inches / mm	MAXIMUM inches / mm
A	.028 / 0.71	.032 / 0.81
B	.740 / 18.80	
C	.245 / 6.22	.255 / 6.48
D	.128 / 3.25	.132 / 3.35
E	.125 / 3.18	
F	.110 / 2.79	.117 / 2.97
G	.117 / 2.97	
H	.560 / 14.22	.570 / 14.48
I	.790 / 20.07	.810 / 20.57
J	.225 / 5.72	.235 / 5.97
K	.165 / 4.19	.185 / 4.70
L	.003 / 0.08	.007 / 0.18
M	.058 / 1.47	.068 / 1.73
N	.119 / 3.02	.135 / 3.43
P	.149 / 3.78	.187 / 4.75

ORDER CODE: ASI10639

CHARACTERISTICS $T_C = 25^\circ\text{C}$

SYMBOL	TEST CONDITIONS	MINIMUM	TYPICAL	MAXIMUM	UNITS
BV_{CBO}	$I_C = 1.0\text{ mA}$	45			V
BV_{CER}	$I_C = 5.0\text{ mA}$ $R_{BE} = 10\ \Omega$	45			V
BV_{EBO}	$I_E = 1.0\text{ mA}$	3.5			V
I_{CBO}	$V_{CB} = 28\text{ V}$			0.5	mA
h_{FE}	$V_{CE} = 5.0\text{ V}$ $I_C = 500\text{ mA}$	30		300	---
C_{OB}	$V_{CB} = 28\text{ V}$ $f = 1.0\text{ MHz}$			15	pF
P_G	$V_{CC} = 21\text{ V}$ $I_{CQ} = 300\text{ mA}$ $f = 2.3\text{ GHz}$	4.5			dB
η_C	$P_{OUT} = 2.0\text{ W}$		30		%